MOSFETs Silicon N-Channel MOS (DTMOSVI)

# TK115E65Z5

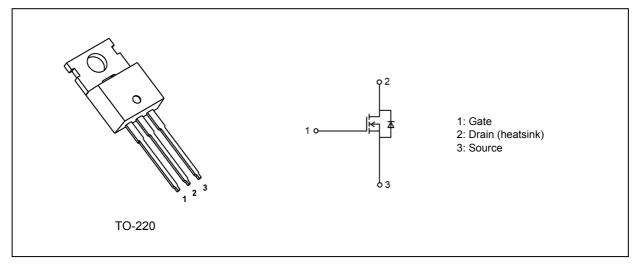
### 1. Applications

• Switching Voltage Regulators

### 2. Features

- (1) Fast reverse recovery time:  $t_{rr} = 110$  ns (typ.)
- (2) Low drain-source on-resistance:  $R_{DS(ON)} = 0.088 \Omega$  (typ.)
- (3) High-speed switching properties with lower capacitance.
- (4) Enhancement mode:  $V_{th}$  = 3.5 to 4.5 V ( $V_{DS}$  = 10 V,  $I_D$  = 1.02 mA)

## 3. Packaging and Internal Circuit



Rev.1.0

## 4. Absolute Maximum Ratings (Note) ( $T_a = 25 \ ^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	650	V
Gate-source voltage		V <sub>GSS</sub>	±30	
Drain current (DC)	(Note 1)	Ι <sub>D</sub>	24	A
Drain current (pulsed)	(Note 1)	I <sub>DP</sub>	96	]
Power dissipation	(T <sub>c</sub> = 25 °C)	PD	190	w
Single-pulse avalanche energy	(Note 2)	E <sub>AS</sub>	325	mJ
Single-pulse avalanche current		I <sub>AS</sub>	4.8	A
Reverse drain current (DC)	(Note 1)	I <sub>DR</sub>	24	
Reverse drain current (pulsed)	(Note 1)	I <sub>DRP</sub>	96	
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature		T <sub>stg</sub>	-55 to 150	
Mounting torque		TOR	0.6	N·m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R <sub>th(ch-c)</sub>	0.657	°C/W
Channel-to-ambient thermal resistance	R <sub>th(ch-a)</sub>	83.3	

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: V\_{DD} = 90 V, T\_{ch} = 25 °C (initial), L = 25.0 mH, I\_{AS} = 4.8 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

## 6. Electrical Characteristics

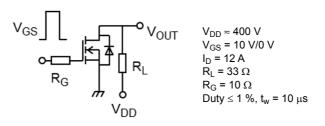
## 6.1. Static Characteristics ( $T_a = 25$ °C unless otherwise specified)

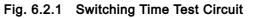
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V	_	_	±1	μA
Drain cut-off current	I <sub>DSS</sub>	$V_{DS}$ = 650 V, $V_{GS}$ = 0 V	_	_	100	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	650	_	—	V
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.02 mA	3.5	_	4.5	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12 A		0.088	0.115	Ω

## 6.2. Dynamic Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 300 V, V <sub>GS</sub> = 0 V, f = 100	—	2280	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	kHz		2.6	_	
Output capacitance		C <sub>oss</sub>			55	_	]
Effective output capacitance (energy related)	(Note 3)	C <sub>o(er)</sub>	$V_{DS}$ = 0 to 400 V, $V_{GS}$ = 0 V	_	90	—	
Effective output capacitance (time related)	(Note 4)	C <sub>o(tr)</sub>	$V_{DS}$ = 0 to 400 V, $V_{GS}$ = 0 V	—	600	—	
Gate resistance		rg	V <sub>DS</sub> = OPEN , f = 1 MHz	_	3.2	_	Ω
Switching time (rise time)		t <sub>r</sub>	See Fig. 6.2.1		25	_	ns
Switching time (turn-on time)		t <sub>on</sub>			54	_	
Switching time (fall time)		t <sub>f</sub>	]	_	3.7	_	
Switching time (turn-off time)		t <sub>off</sub>	1	_	83	_	1
MOSFET dv/dt ruggedness		dv/dt	$V_{DS} \leq V_{DSS}, \ I_D \leq 12 \ A$	90	_	_	V/ns

Note 3:  $C_{O(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{OSS}$  while  $V_{DS}$  is rising from 0 V to 400 V. Note 4:  $C_{O(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{OSS}$  while  $V_{DS}$  is rising from 0 V to 400 V.





## 6.3. Gate Charge Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 400$ V, $V_{GS}$ = 10 V, $I_D$ = 24 A	_	42	—	nC
Gate-source charge 1	Q <sub>gs1</sub>		_	14	_	
Gate-drain charge	Q <sub>gd</sub>			14	_	

## 6.4. Source-Drain Characteristics (T<sub>a</sub> = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 24 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time (Note 5)	t <sub>rr</sub>	V <sub>DD</sub> = 400 V,	_	110	176	ns
Reverse recovery charge	Q <sub>rr</sub>	I <sub>DR</sub> = 12 A, V <sub>GS</sub> = 0 V -dI <sub>DR</sub> /dt = 100 A/μs	_	0.52	—	μC
Peak reverse recovery current	۱ <sub>rr</sub>	-αιρκίαι – 100 Αίμα	_	9.5	_	A
Diode dv/dt ruggedness	dv/dt	$V_{DD} \leq 400$ V, $I_{DR} \leq 12$ A, $V_{GS}$ = 0 V	70		_	V/ns

Note 5: Defined by design.

### 7. Marking

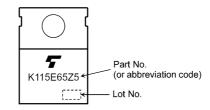
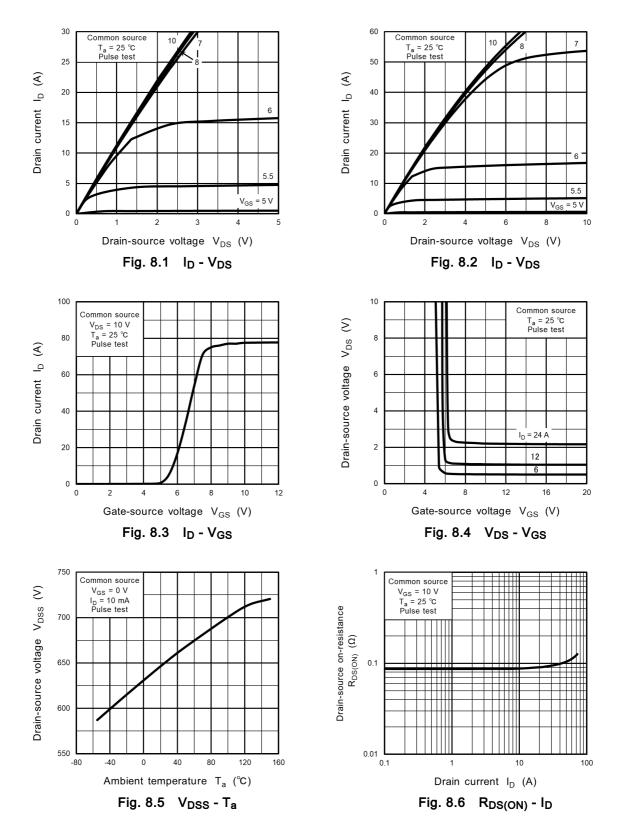
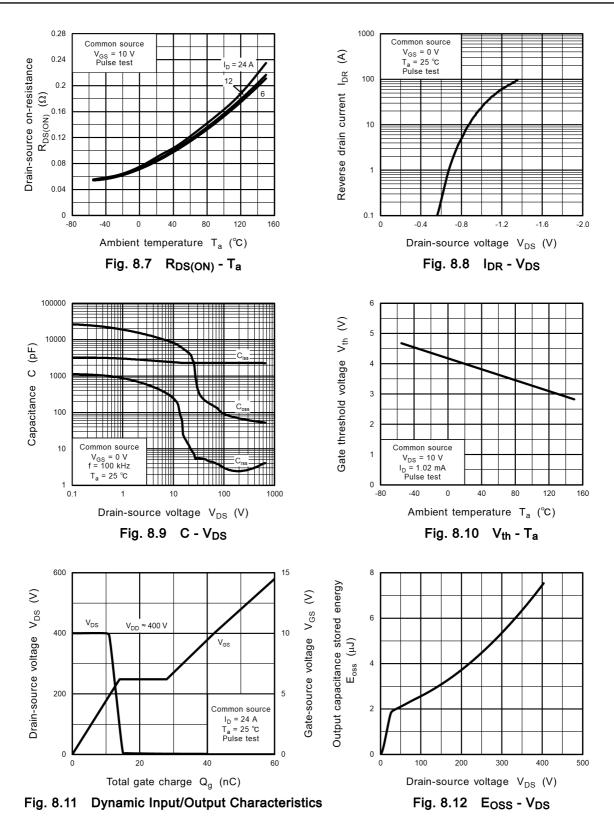


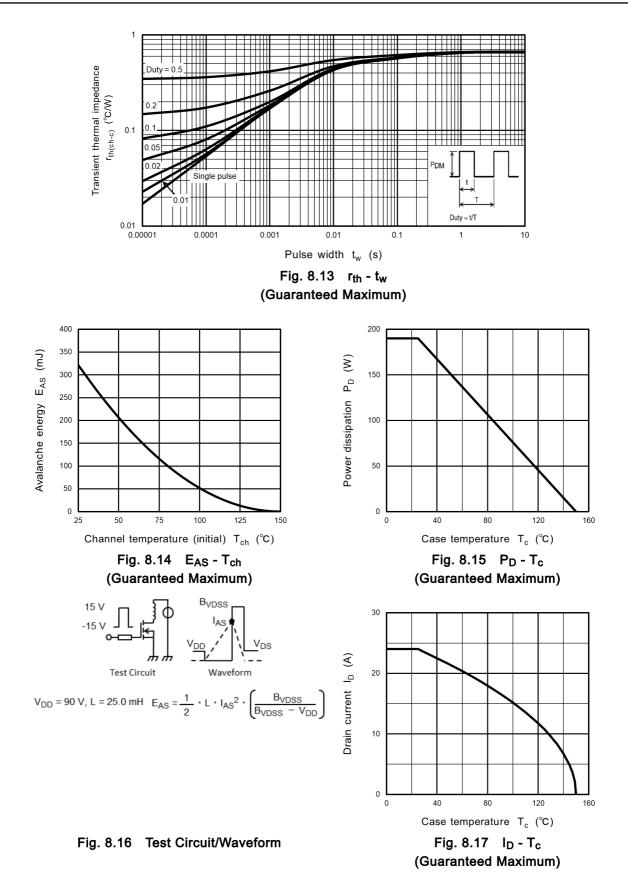
Fig. 7.1 Marking

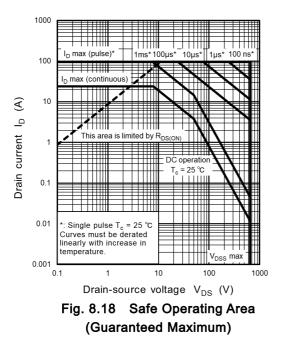
## 8. Characteristics Curves (Note)









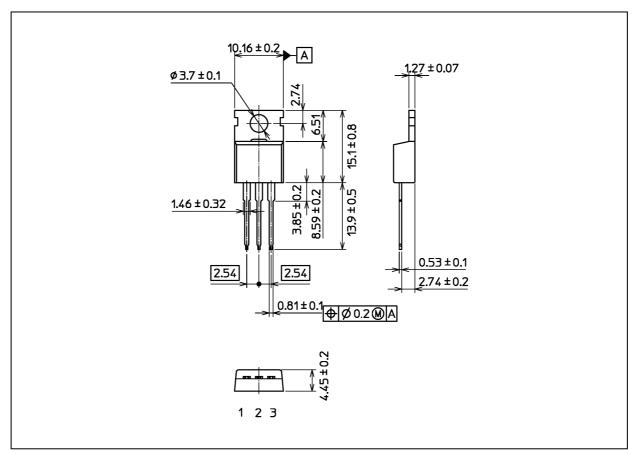


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## TK115E65Z5

## **Package Dimensions**

Unit: mm



#### Weight: 1.93 g (typ.)

	Package Name(s)
TOSHIBA: 2-10X1A	
Nickname: TO-220	

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